

DESCRIPTION

The SPP3401W is the P-Channel logic enhancement mode power field effect transistors are produced using high cell density, DMOS trench technology.

This high density process is especially tailored to minimize on-state resistance.

These devices are particularly suited for low voltage application such as cellular phone and notebook computer power management and other battery powered circuits, and low in-line power loss are needed in a very small outline surface mount package.

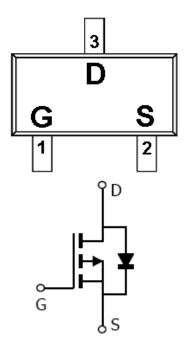
FEATURES

- -30V/-4.0A, RDS(ON)= $70m\Omega$ @VGS=- 10V
- -30V/-3.2A, RDS(ON)= $90m\Omega$ @VGS=-4.5V
- -30V/-1.2A, RDS(ON)= $115m\Omega$ @VGS=-2.5V
- ◆ Super high density cell design for extremely low RDS (ON)
- Exceptional on-resistance and maximum DC current capability
- ♦ SOT-23 package design

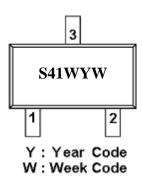
APPLICATIONS

- Power Management in Note book
- Portable Equipment
- Battery Powered System
- DC/DC Converter
- Load Switch
- DSC
- LCD Display inverter

PIN CONFIGURATION(SOT-23)



PART MARKING





PIN DESCRIPTION

Pin	Symbol	Description
1	G	Gate
2	S	Source
3	D	Drain

ORDERING INFORMATION

Part Number	Package	Part Marking
SPP3401WS23RG	SOT-23	S41W

% Week Code : $A \sim Z(1 \sim 26)$; $a \sim z(27 \sim 52)$

※ SPP3401WS23RG: Tape Reel; Pb − Free

ABSOULTE MAXIMUM RATINGS

(Ta=25°C Unless otherwise noted)

Parameter		Symbol	Typical	Unit
Drain-Source Voltage		Vdss	-30	V
Gate –Source Voltage		VGSS	±12	V
Continue Durin Community 150°C	TA=25°C	T	-4.0	
Continuous Drain Current(TJ=150°C)	TA=70°C	Id	-3.2	A
Pulsed Drain Current	IDM	-15	A	
Continuous Source Current(Diode Conduction)		Is	-1.0	A
D	TA=25°C	PD	1.25	***
Power Dissipation	TA=70°C		0.8	W
Operating Junction Temperature		TJ	150	$^{\circ}\!\mathbb{C}$
Storage Temperature Range		Tstg	-55/150	$^{\circ}\!\mathbb{C}$
Thermal Resistance-Junction to Ambient		RθJA	120	°C/W

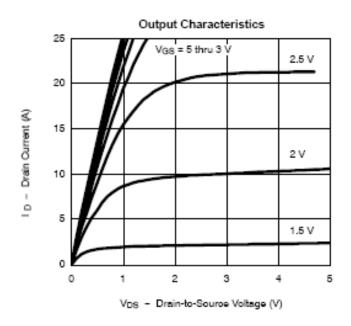


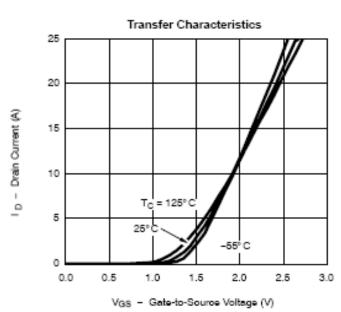
ELECTRICAL CHARACTERISTICS

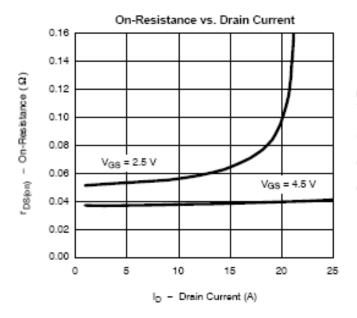
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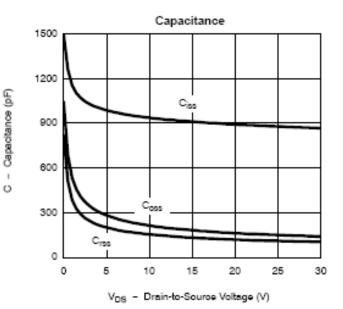
Parameter	Symbol	Conditions	Min.	Тур	Max.	Unit	
Static	•						
Drain-Source Breakdown Voltage	V(BR)DSS	V _G S=0V,I _D =-250uA	-30			V	
Gate Threshold Voltage	VGS(th)	VDS=VGS,ID=-250uA	-0.4		-1.0] V	
Gate Leakage Current	Igss	V _{DS} =0V,V _{GS} =±12V			±100	nA	
		V _{DS} =-24V,V _{GS} =0V			-1		
Zero Gate Voltage Drain Current	Idss	V _{DS} =-24V,V _{GS} =0V T _J =55°C			-10	uA	
On-State Drain Current	ID(on)	$V_{DS} \leq -5V, V_{GS} = -10V$	-10			A	
		V _{GS} =- 10V,I _D =-4.0A		0.068	0.077	Ω	
Drain-Source On-Resistance	RDS(on)	V _G S=-4.5V,I _D =-3.2A		0.088	0.099		
	C	V _G S=-2.5V,I _D =-1.2A		0.118	0.127	-	
Forward Transconductance	gfs	VDS=-5.0V,ID=-4.0A		10		S	
Diode Forward Voltage	Vsd	Is=-1.0A,VGS=0V		-0.8	-1.2	V	
Dynamic							
Total Gate Charge	Qg			10	18	nC	
Gate-Source Charge	Qgs	V _{DS} =-15V,V _{GS} =-10V I _D =-4.0A		1.6			
Gate-Drain Charge	Qgd	-ID4.0A		3.0			
Input Capacitance	Ciss			450		pF	
Output Capacitance	Coss	V _{DS} =-15V,V _{GS} =0V f=1MHz		95			
Reverse Transfer Capacitance	Crss	I-IMITZ		55			
Turn-On Time	td(on)			8	18	ns	
	t _r	$V_{DD}=-15V,R_{L}=15\Omega$		8	18		
	td(off)	-ID≡-1.0A,VGEN=-10V RG=6Ω		25	50		
Turn-Off Time	tf	110-022		25	35		

TYPICAL CHARACTERISTICS

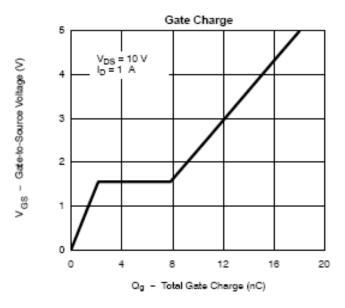


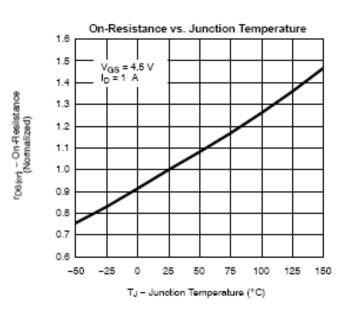


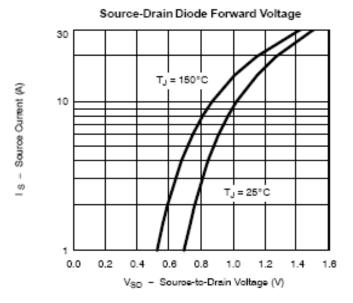


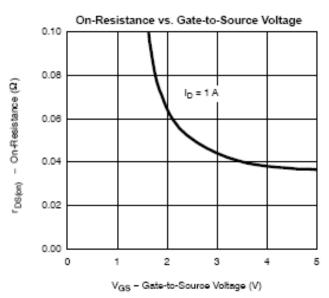


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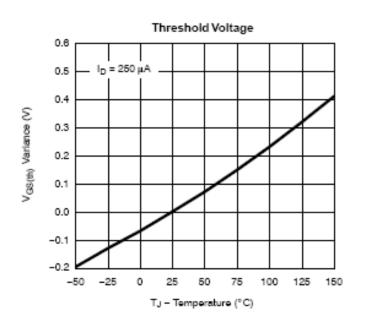


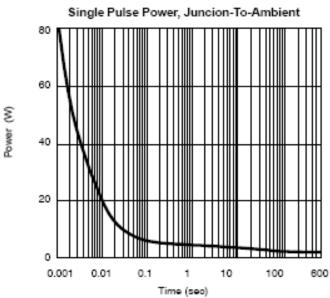


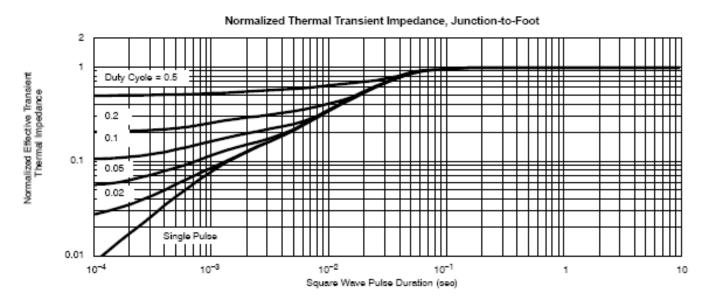




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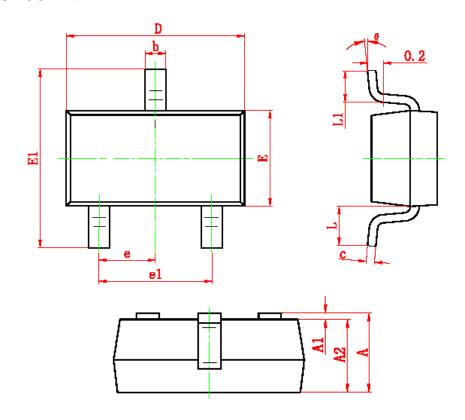








SOT-23 PACKAGE OUTLINE



Symbol	Dimensions In Millimeters		Dimensions In Inches		
	Min	Max	Min	Max	
Α	0.900	1.200	0.035	0.043	
A1	0.000	0.100	0.000	0.004	
A2	0.900	1.100	0.035	0.039	
b	0.300	0.500	0.012	0.020	
С	0.080	0.150	0.003	0.006	
D	2.800	3.000	0.110	0.118	
E	1.200	1.400	0.047	0.055	
E1	2.250	2.550	0.089	0.100	
е	0.950 TYP		0.037 TYP		
e1	1.800	2.000	0.071	0.079	
L	0.550 REF		0.022 REF		
L1	0.300	0.500	0.012	0.020	
θ	0°	8°	0°	6°	

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